



Changes:

- R1 from 2k2 to 4k7 to meet 1mA max current on V3P3OUT
- Sense resistor R2, R3 to 0.1ohm (256mW dissipation for 1.6A current)

TITLE	
FILE:	REVISION:
PAGE	DRAWN BY:
OF	

# 1. Table of Contents (This Page)

Created on Thu Mar 17 22:38:21 2011

2. component

3. solder

4. plated-drill

5. componentmask

6. soldermask

7. topsilk

8. bottomsilk

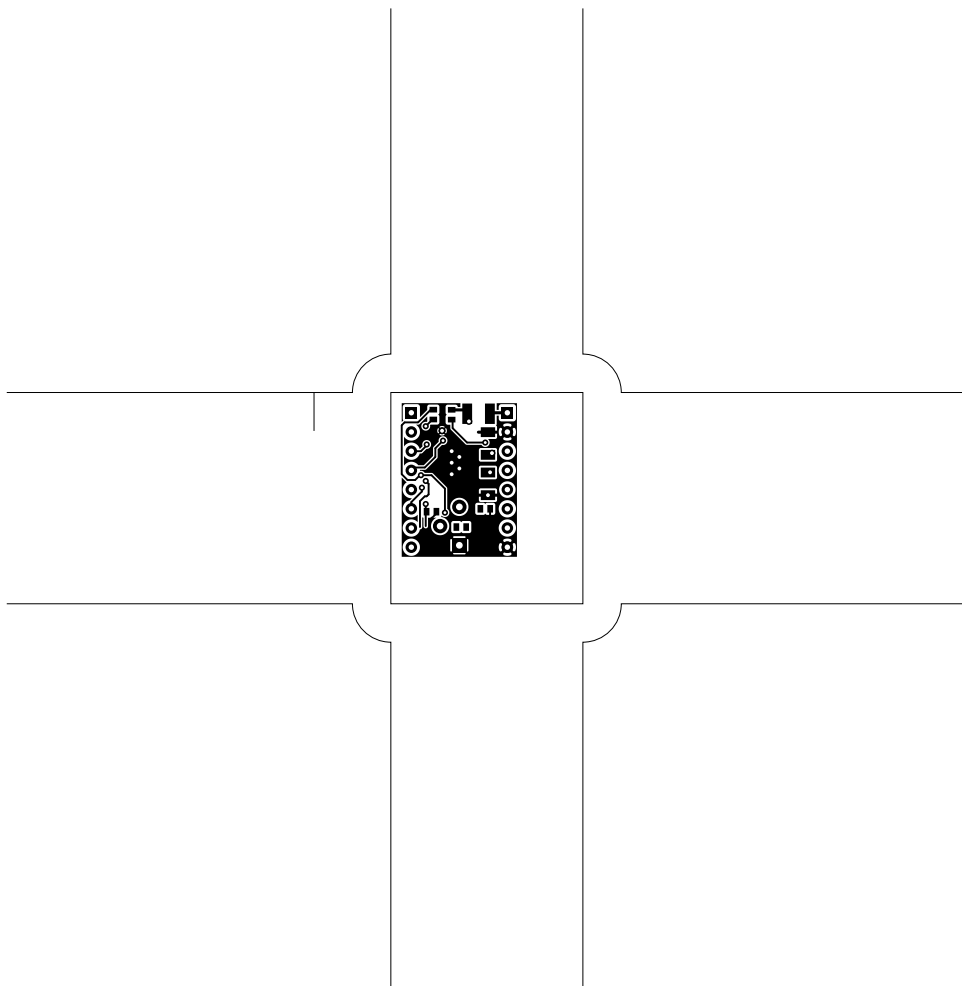
9. bottompaste

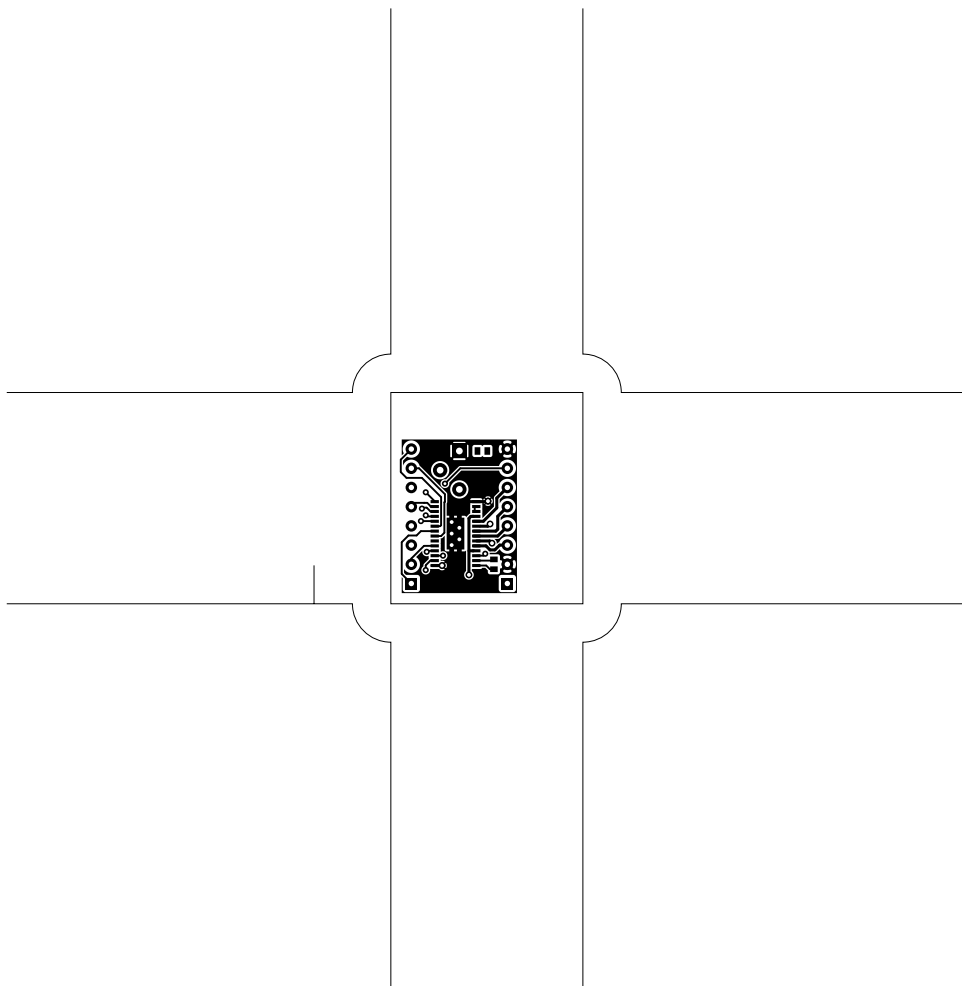
10. toppaste

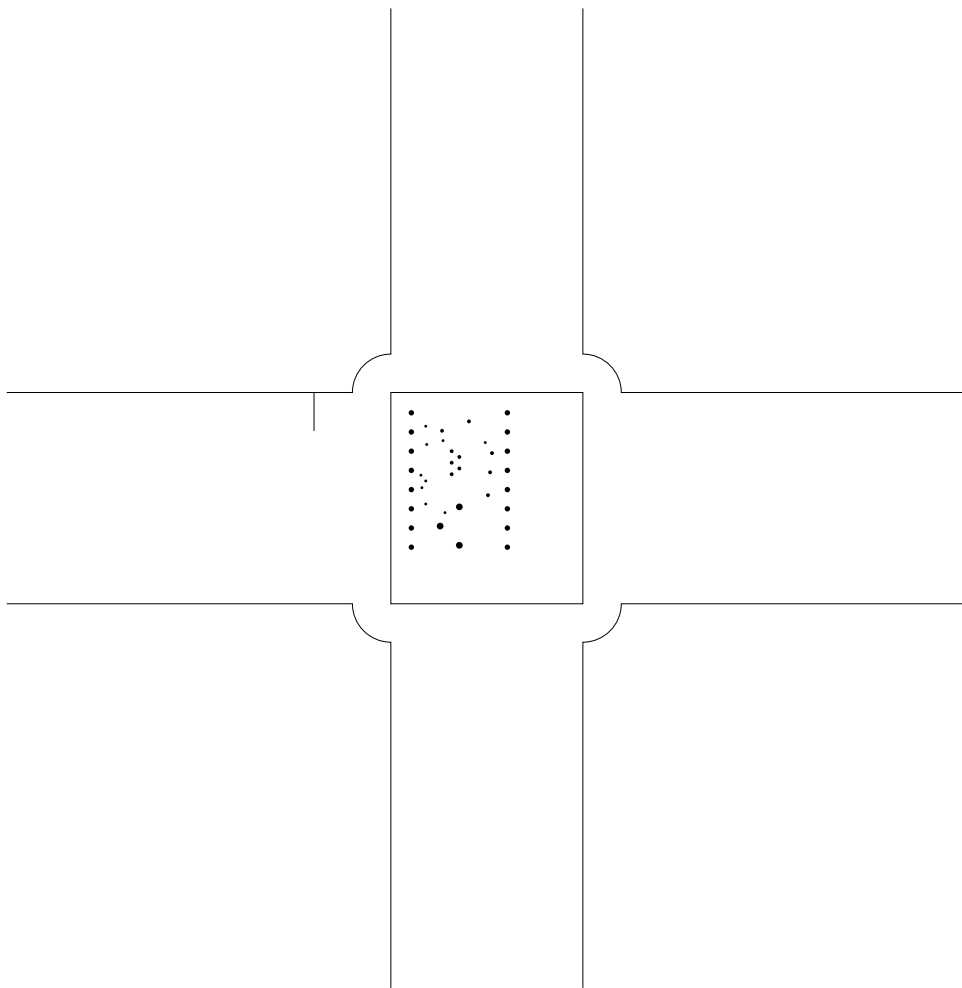
11. topassembly

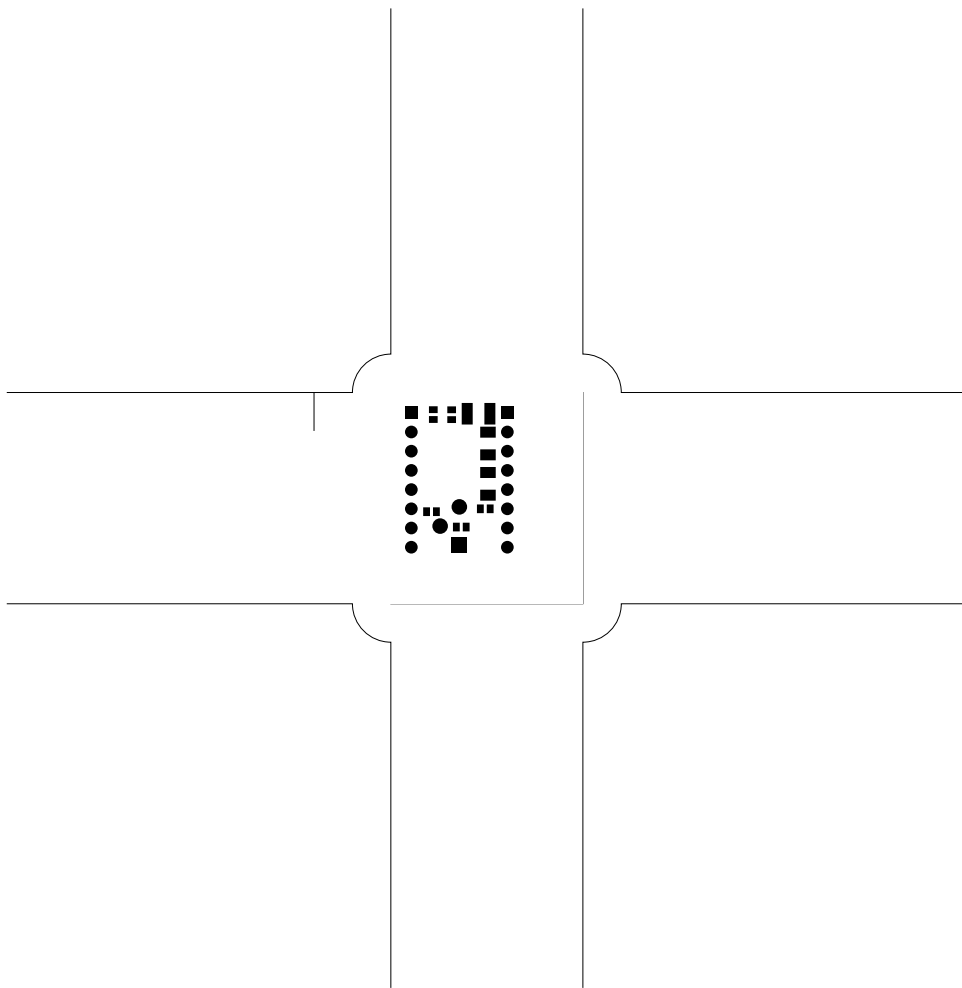
12. bottomassembly

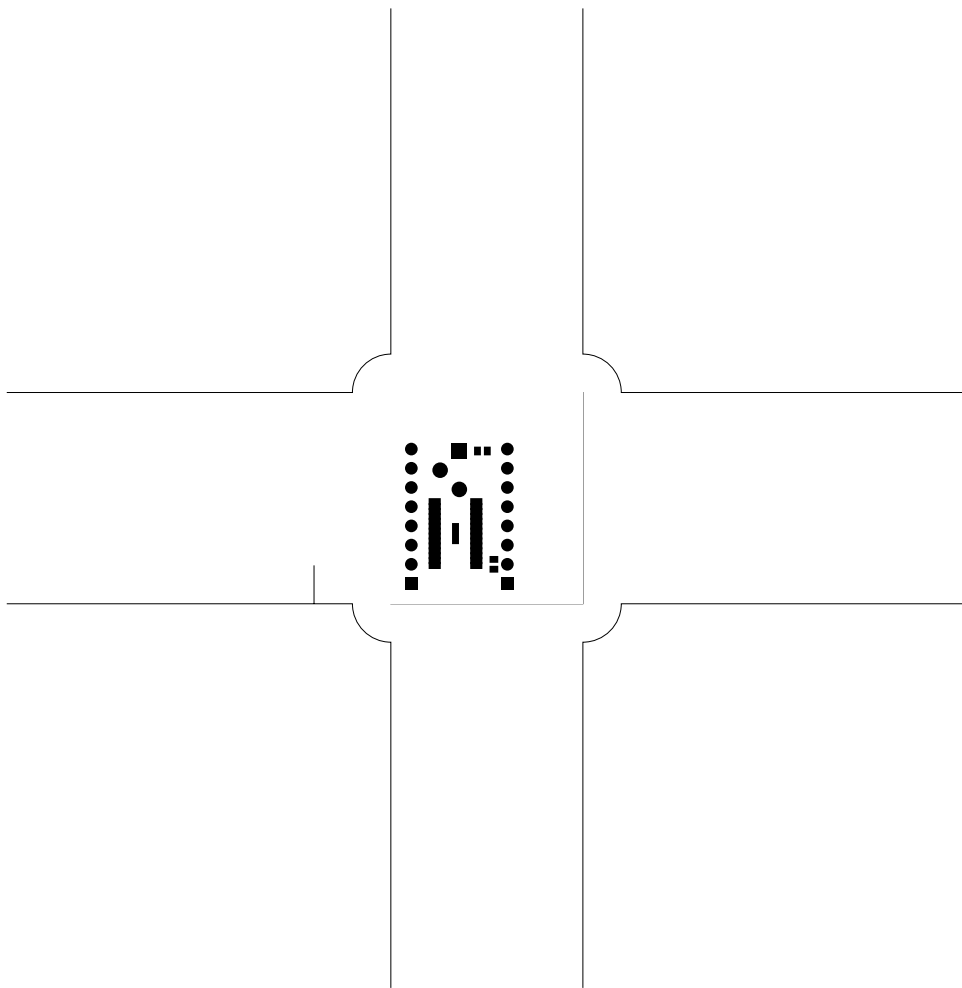
13. fab

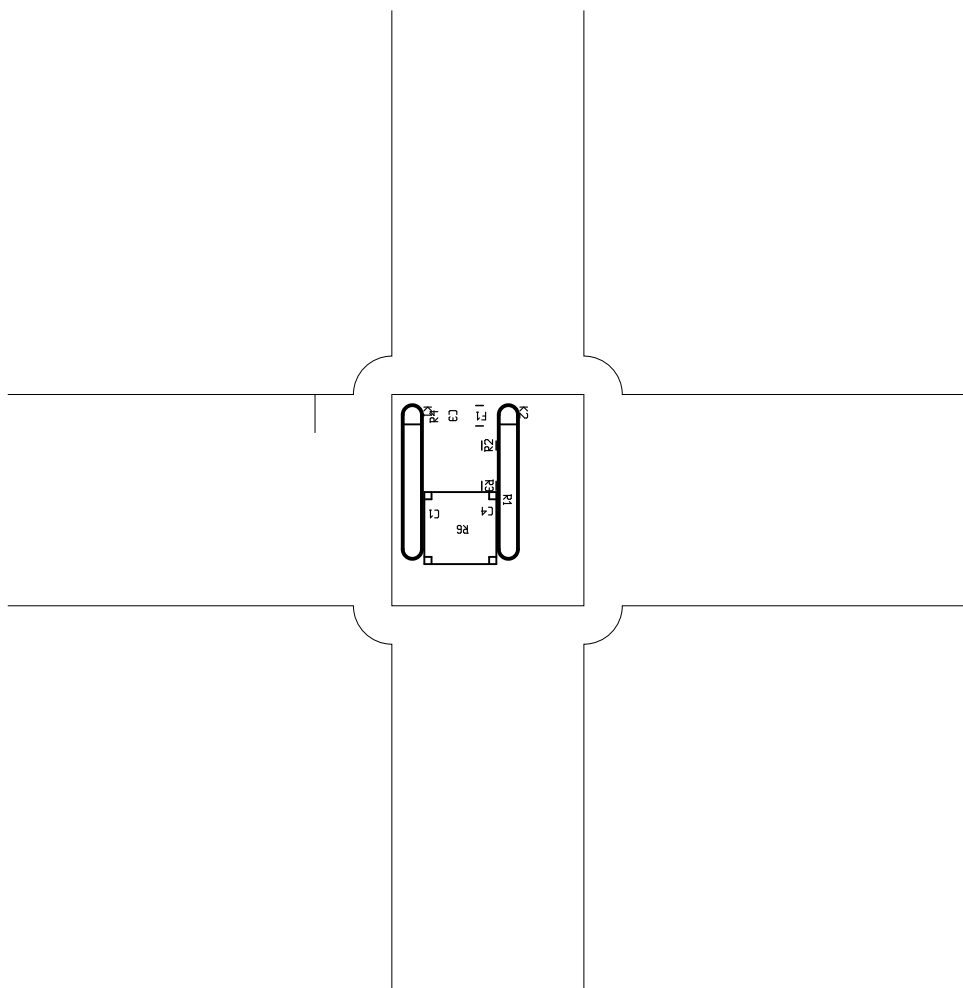




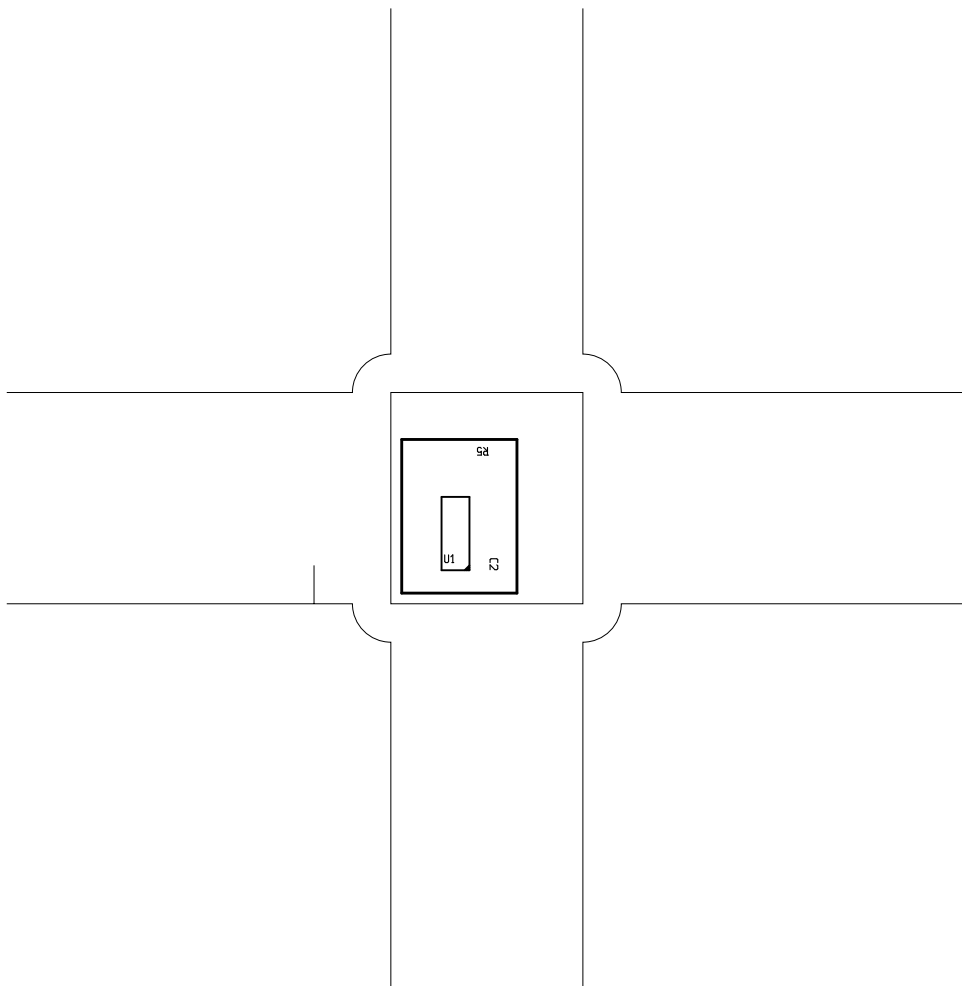


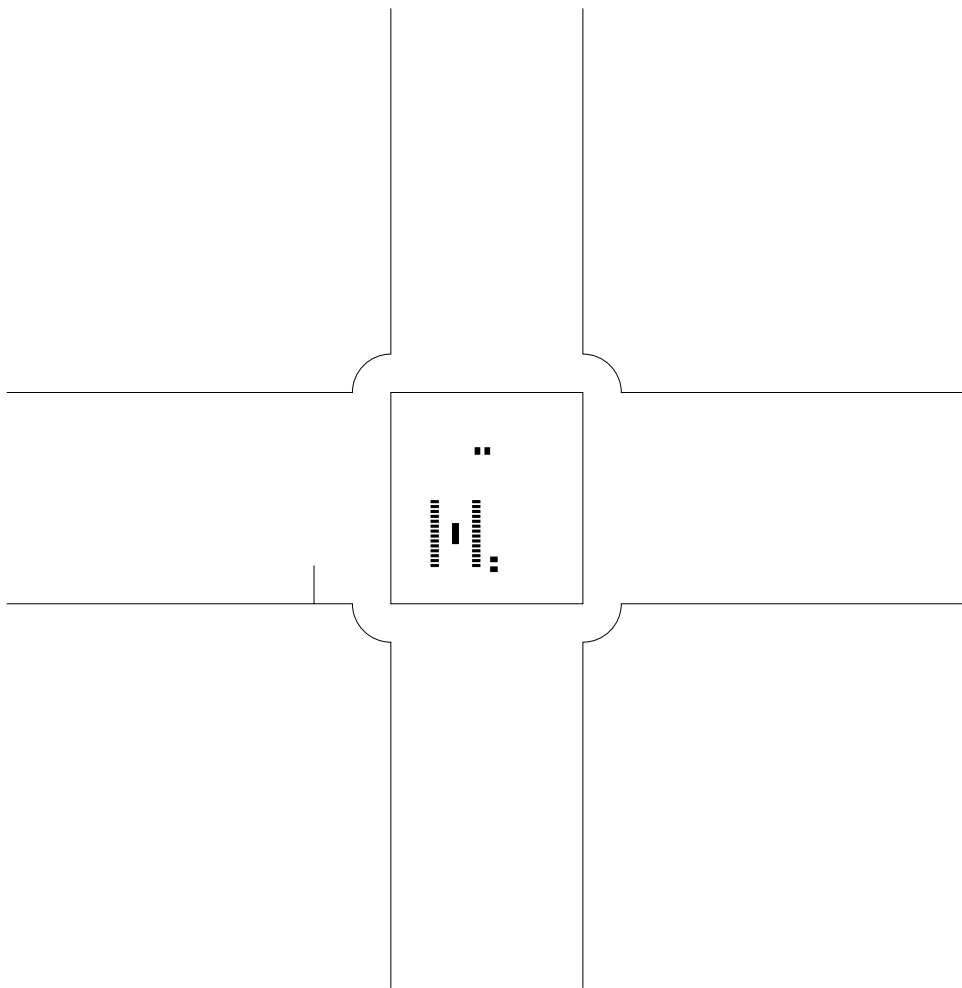


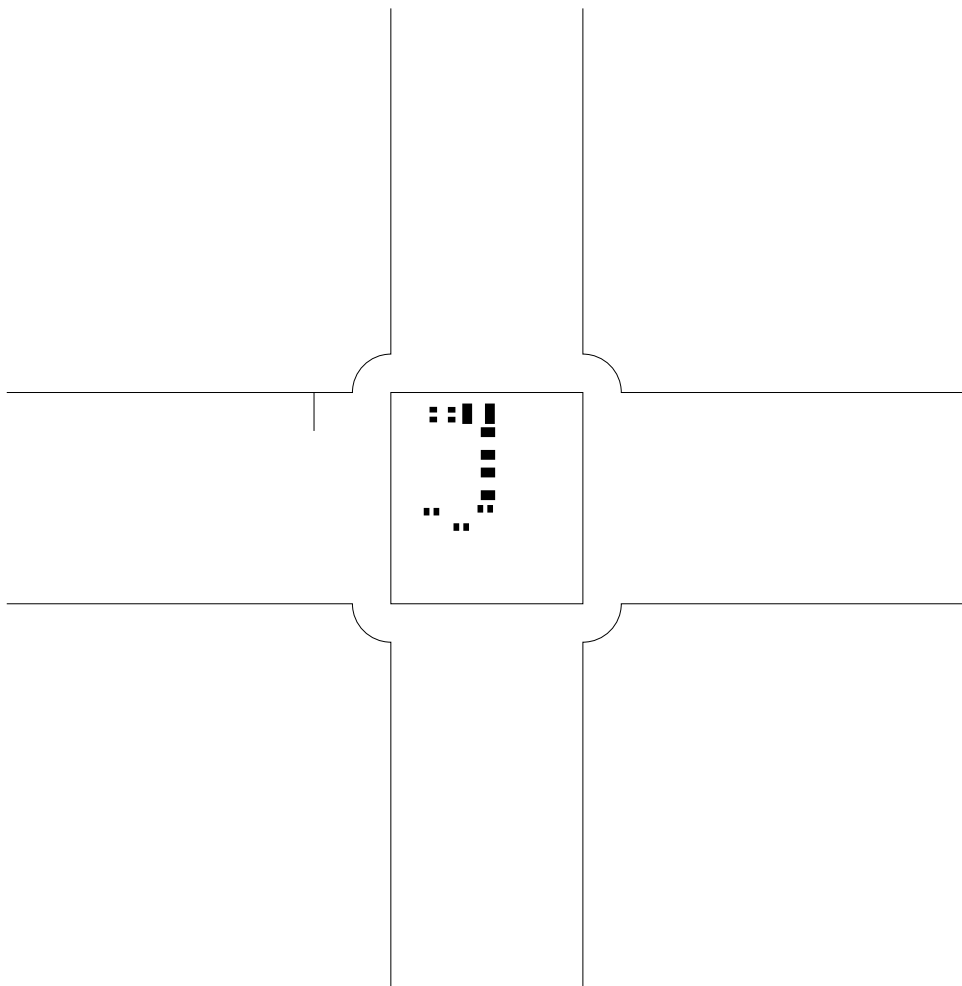


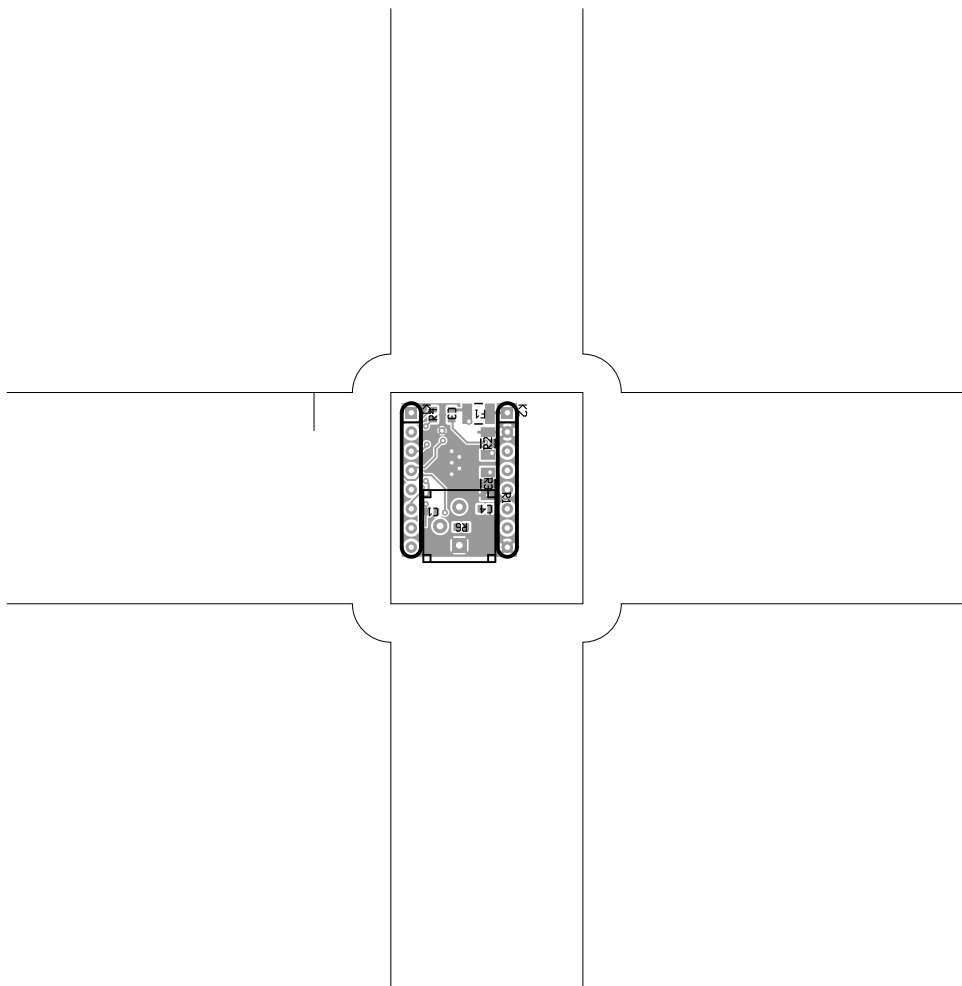


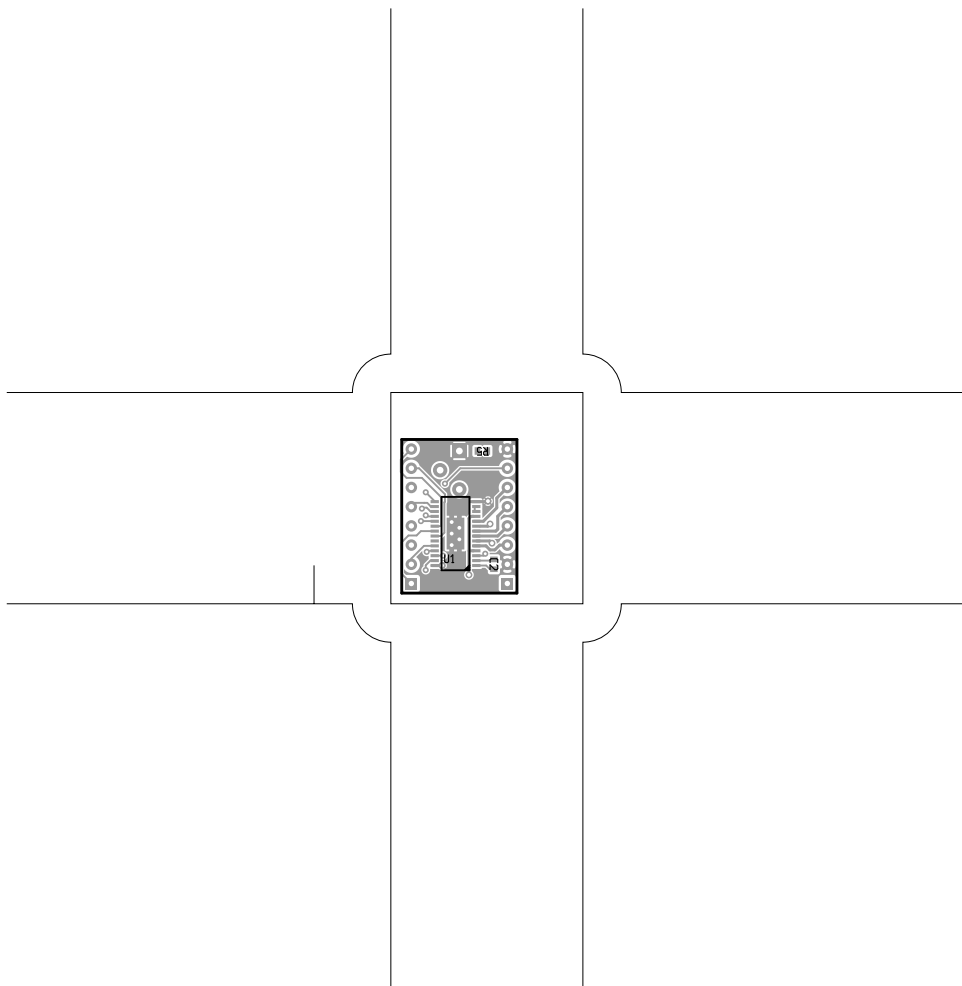












There are 4 different drill sizes used in this layout, 38 holes total

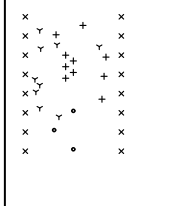
Symbol	Diam. (Inch)	Count	Plated?
Y	<u>0.015</u>	<u>9</u>	<u>YES</u>
+	<u>0.020</u>	<u>10</u>	<u>YES</u>
x	<u>0.028</u>	<u>16</u>	<u>YES</u>
•	<u>0.035</u>	<u>3</u>	<u>YES</u>

Title: (unknown) - Fabrication Drawing

Author:

Date: Thu Mar 17 21:38:21 2011 UTC

Maximum Dimensions: 1000 mils wide, 1100 mils high



Board outline is the centerline of this 10 mil rectangle - 0,0 to 1000,1100 mils